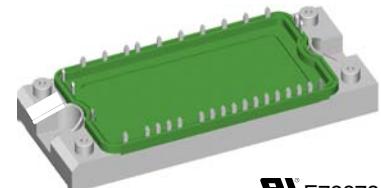
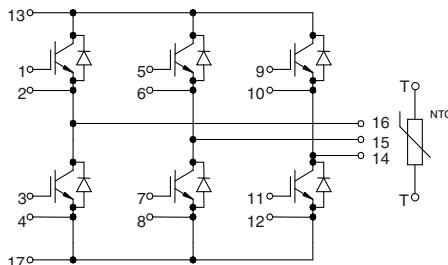


IGBT Modules

Sixpack

Short Circuit SOA Capability
Square RBSOA

Type	NTC - Option
MWI 75-06 A7	without NTC
MWI 75-06 A7T	with NTC



E72873

See outline drawing for pin arrangement

IGBTs

Symbol	Conditions	Maximum Ratings		
V_{CES}	$T_{VJ} = 25^\circ\text{C}$ to 150°C	600		V
V_{GES}		± 20		V
I_{C25}	$T_C = 25^\circ\text{C}$	90		A
I_{C80}	$T_C = 80^\circ\text{C}$	60		A
RBSOA	$V_{GE} = \pm 15 \text{ V}$; $R_G = 18 \Omega$; $T_{VJ} = 125^\circ\text{C}$ Clamped inductive load; $L = 100 \mu\text{H}$	$I_{CM} = 120$		A
		$V_{CEK} \leq V_{CES}$		
t_{sc} (SCSOA)	$V_{CE} = V_{CES}$; $V_{GE} = \pm 15 \text{ V}$; $R_G = 18 \Omega$; $T_{VJ} = 125^\circ\text{C}$ non-repetitive	10		μs
P_{tot}	$T_C = 25^\circ\text{C}$	280		W

Symbol

Conditions

Characteristic Values
($T_{VJ} = 25^\circ\text{C}$, unless otherwise specified)

		min.	typ.	max.
$V_{CE(sat)}$	$I_C = 75 \text{ A}$; $V_{GE} = 15 \text{ V}$; $T_{VJ} = 25^\circ\text{C}$ $T_{VJ} = 125^\circ\text{C}$	2.1	2.6	V
		2.5		V
$V_{GE(th)}$	$I_C = 1.5 \text{ mA}$; $V_{GE} = V_{CE}$	4.5		V
I_{CES}	$V_{CE} = V_{CES}$; $V_{GE} = 0 \text{ V}$; $T_{VJ} = 25^\circ\text{C}$ $T_{VJ} = 125^\circ\text{C}$		1.3	mA
I_{GES}	$V_{CE} = 0 \text{ V}$; $V_{GE} = \pm 20 \text{ V}$		200	nA
$t_{d(on)}$ t_r $t_{d(off)}$ t_f E_{on} E_{off}	$\left. \begin{array}{l} \text{Inductive load, } T_{VJ} = 125^\circ\text{C} \\ V_{CE} = 300 \text{ V}; I_C = 75 \text{ A} \\ V_{GE} = \pm 15 \text{ V}; R_G = 18 \Omega \end{array} \right\}$	50		ns
		50		ns
		270		ns
		40		ns
		3.5		mJ
		2.5		mJ
C_{ies}	$V_{CE} = 25 \text{ V}$; $V_{GE} = 0 \text{ V}$; $f = 1 \text{ MHz}$	3200		pF
Q_{Gon}	$V_{CE} = 300 \text{ V}$; $V_{GE} = 15 \text{ V}$; $I_C = 75 \text{ A}$	190		nC
R_{thJC}	(per IGBT)		0.44	K/W

IXYS reserves the right to change limits, test conditions and dimensions.

20070912a

Diodes

Symbol	Conditions	Maximum Ratings		
I _{F25}	T _C = 25°C	140	A	
I _{F80}	T _C = 80°C	85	A	

Symbol	Conditions	Characteristic Values		
		min.	typ.	max.
V _F	I _F = 75 A; V _{GE} = 0 V; T _{VJ} = 25°C T _{VJ} = 125°C	1.8 1.3	2.1 V	V
I _{RM} t _{rr}	I _F = 60 A; di _F /dt = -500 A/μs; T _{VJ} = 125°C V _R = 300 V; V _{GE} = 0 V	28 100	A ns	
R _{thJC}	(per diode)		0.61	K/W

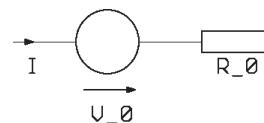
Temperature Sensor NTC (MWI ... A7T version only)

Symbol	Conditions	Characteristic Values		
		min.	typ.	max.
R ₂₅	T = 25°C	4.75	5.0	5.25 kΩ
B _{25/50}			3375	K

Module

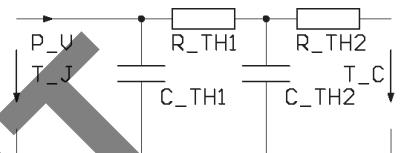
Symbol	Conditions	Maximum Ratings		
T _{VJ}		-40...+150	°C	
T _{stg}		-40...+125	°C	
V _{ISOL}	I _{ISOL} ≤ 1 mA; 50/60 Hz	2500	V~	
M _d	Mounting torque (M5)	2.7 - 3.3	Nm	

Symbol	Conditions	Characteristic Values		
		min.	typ.	max.
R _{pin-chip}		5	mΩ	
d _s d _A	Creepage distance on surface Strike distance in air	6 6	mm mm	
R _{thCH}	with heatsink compound	0.02	K/W	
Weight		180	g	

Equivalent Circuits for Simulation**Conduction**

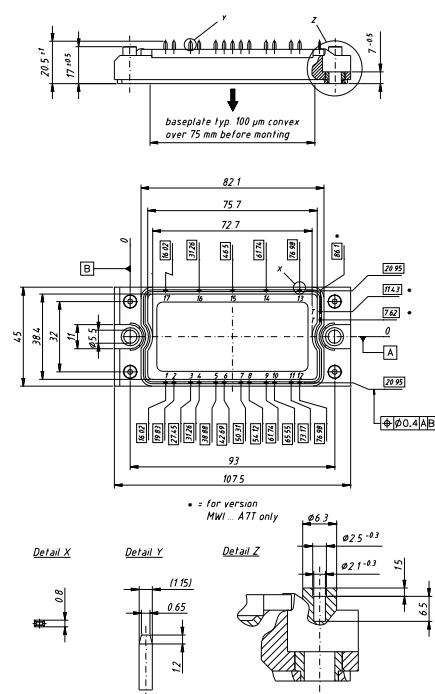
IGBT (typ. at V_{GE} = 15 V; T_J = 125°C)
V₀ = 0.95 V; R₀ = 20 mΩ

Free Wheeling Diode (typ. at T_J = 125°C)
V₀ = 1.014 V; R₀ = 4 mΩ

Thermal Response

IGBT (typ.)
C_{th1} = 0.248 J/K; R_{th1} = 0.343 K/W
C_{th2} = 1.849 J/K; R_{th2} = 0.097 K/W

Free Wheeling Diode (typ.)
C_{th1} = 0.23 J/K; R_{th1} = 0.483 K/W
C_{th2} = 1.3 J/K; R_{th2} = 0.127 K/W

Dimensions in mm (1 mm = 0.0394")

Higher magnification on page B3 - 72

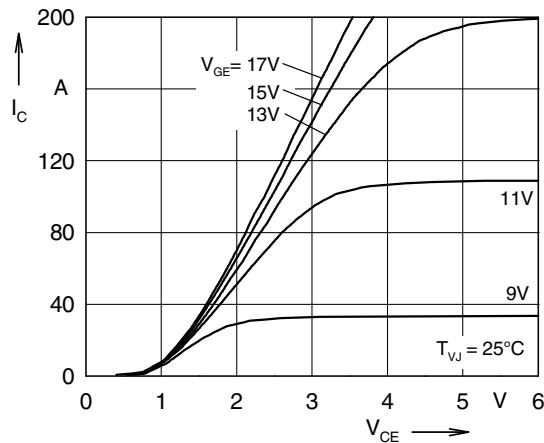


Fig. 1 Typ. output characteristics

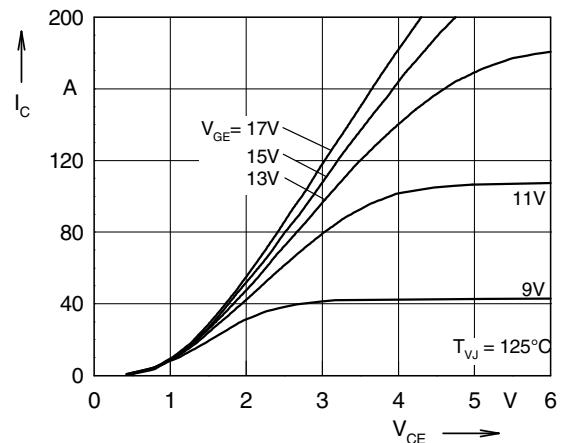


Fig. 2 Typ. output characteristics

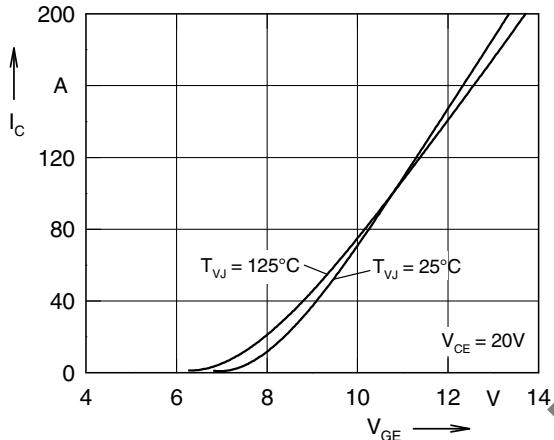


Fig. 3 Typ. transfer characteristics

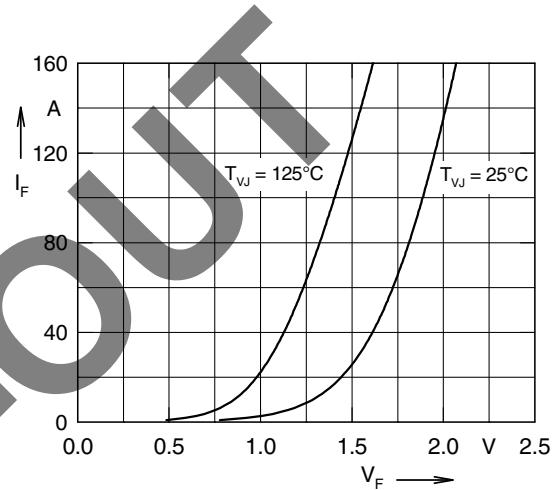


Fig. 4 Typ. forward characteristics of free wheeling diode

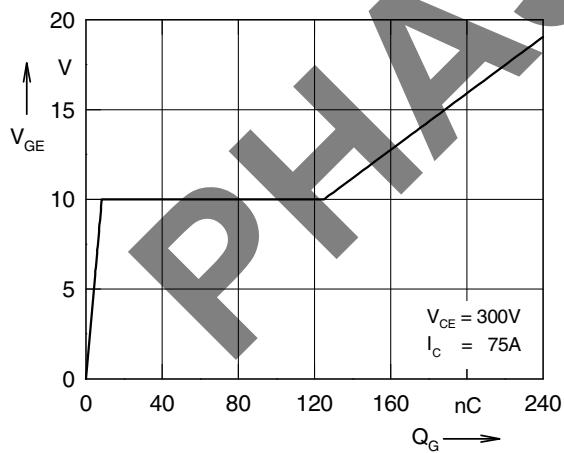


Fig. 5 Typ. turn on gate charge

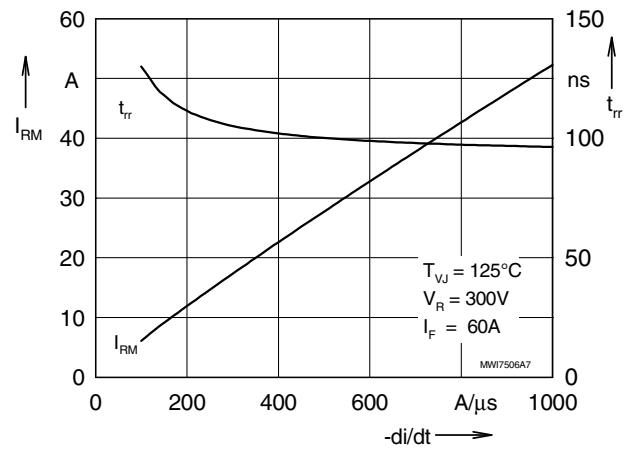


Fig. 6 Typ. turn off characteristics of free wheeling diode

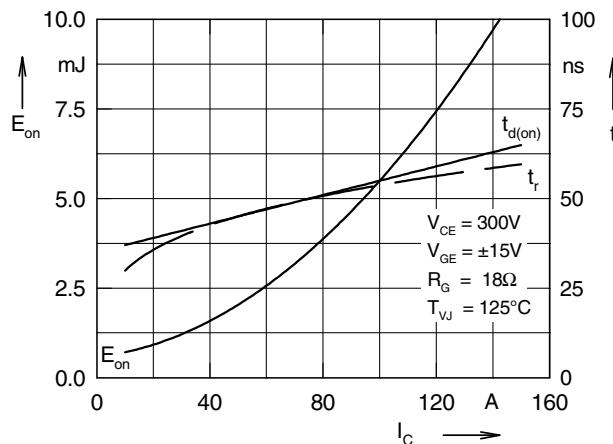


Fig. 7 Typ. turn on energy and switching times versus collector current

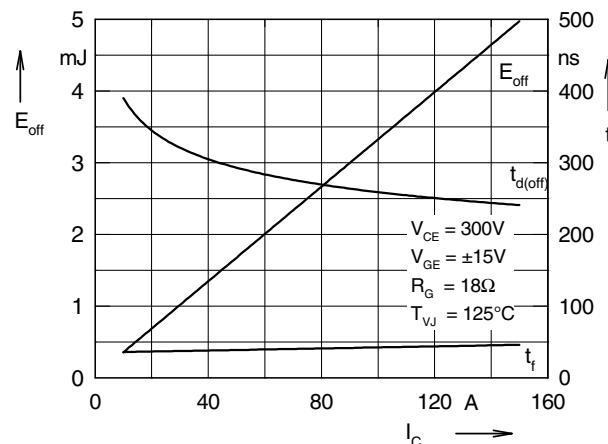


Fig. 8 Typ. turn off energy and switching times versus collector current

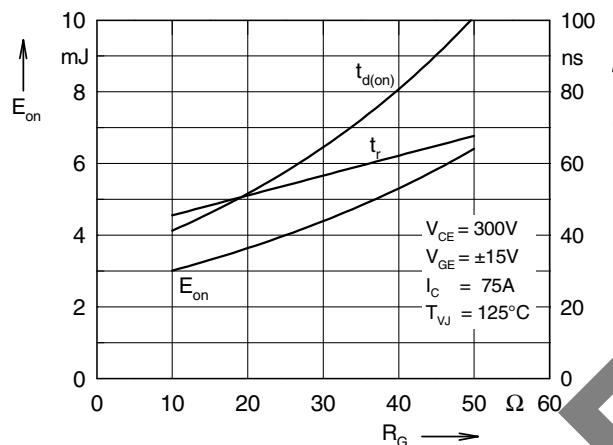


Fig. 9 Typ. turn on energy and switching times versus gate resistor

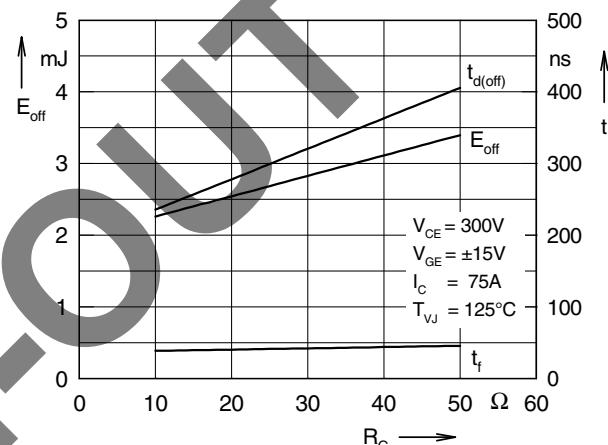


Fig. 10 Typ. turn off energy and switching times versus gate resistor

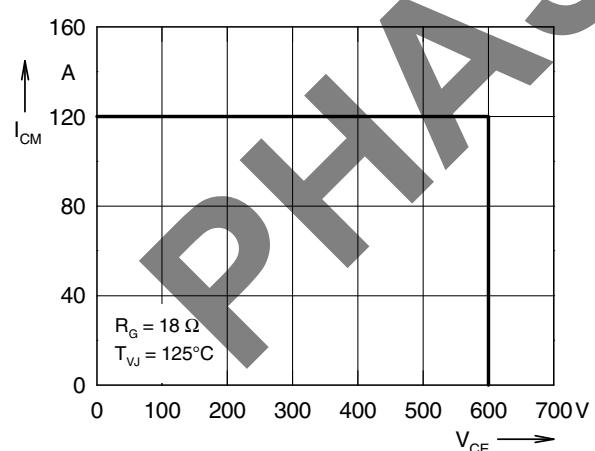


Fig. 11 Reverse biased safe operating area RBSOA

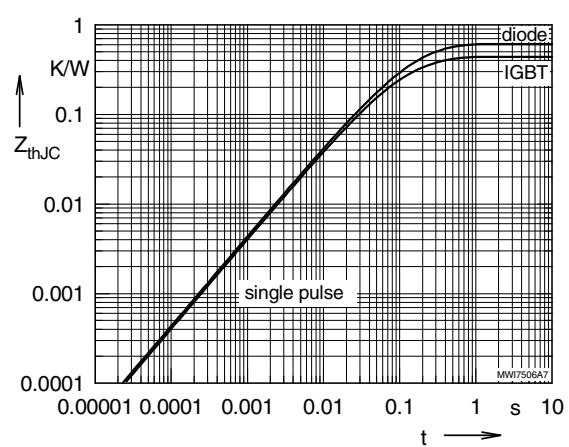


Fig. 12 Typ. transient thermal impedance

X-ON Electronics

Largest Supplier of Electrical and Electronic Components

Click to view similar products for IGBT Modules category:

Click to view products by IXYS manufacturer:

Other Similar products are found below :

[F3L400R07ME4_B22](#) [F4-50R07W2H3_B51](#) [FB15R06W1E3](#) [FB20R06W1E3_B11](#) [FD1000R33HE3-K](#) [FD400R12KE3](#) [FD400R33KF2C-K](#)
[FD401R17KF6C_B2](#) [FD-DF80R12W1H3_B52](#) [FF200R06YE3](#) [FF300R12KE4_E](#) [FF450R12ME4P](#) [FF600R12IP4V](#) [FP20R06W1E3](#)
[FP50R12KT3](#) [FP75R07N2E4_B11](#) [FS10R12YE3](#) [FS150R07PE4](#) [FS150R12PT4](#) [FS200R12KT4R](#) [FS50R07N2E4_B11](#) [FZ1000R33HE3](#)
[FZ1800R17KF4](#) [DD250S65K3](#) [DF1000R17IE4](#) [DF1000R17IE4D_B2](#) [DF1400R12IP4D](#) [DF200R12PT4_B6](#) [DF400R07PE4R_B6](#)
[BSM75GB120DN2_E3223c-Se](#) [F3L300R12ME4_B22](#) [F3L75R07W2E3_B11](#) [F4-50R12KS4_B11](#) [F475R07W1H3B11ABOMA1](#)
[FD1400R12IP4D](#) [FD200R12PT4_B6](#) [FD800R33KF2C-K](#) [FF1200R17KP4_B2](#) [FF150R12ME3G](#) [FF300R17KE3_S4](#) [FF300R17ME4_B11](#)
[FF401R17KF6C_B2](#) [FF650R17IE4D_B2](#) [FF900R12IP4D](#) [FF900R12IP4DV](#) [STGIF7CH60TS-L](#) [FP50R07N2E4_B11](#) [FS100R07PE4](#)
[FS150R07N3E4_B11](#) [FS150R17N3E4](#)